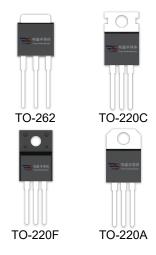
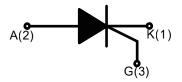
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### **DESCRIPTION:**

With high ability to withstand the shock loading of large current, BT152-600R series of silicon controlled rectifiers provide high dv/dt rate with strong resistance to electromagnetic interference. They are especially recommended for use on solid state relay, motorcycle, power charger, T-tools etc.





#### **MAIN FEATURES**

Symbol	JCT620	JCT820	
V <sub>DRM</sub> / V <sub>RRM</sub>	600V	800V	
I <sub>T(RMS)</sub>	20A		
lgт	≤25mA		

## **ABSOLUTE MAXIMUM RATINGS**

Parameter		Symbol	Value	Unit
Storage junction temperature range		T <sub>stg</sub>	-40-150	$^{\circ}$ C
Operating junction temperature range		Tj	-40-150	$^{\circ}$ C
Repetitive peak off-state voltage(T <sub>j</sub> =25℃)		V <sub>DRM</sub>	600/800	V
Repetitive peak reverse voltage(T <sub>j</sub> =25℃)		V <sub>RRM</sub>	600/800	V
RMS on-state current	TO-220A(Ins)/ TO-220F(Ins)(Tc=95°C) TO-220A(Non-Ins)/ TO-220C (Tc=110°C) TO-262 (Tc=80°C)	I <sub>T(RMS)</sub>	20	А
Non repetitive surge peak on-state current (tp=10ms)		Ітѕм	250	А



I <sup>2</sup> t value for fusing (tp=10ms)	l <sup>2</sup> t	312.5	A <sup>2</sup> s
Critical rate of rise of on-state current (I <sub>G</sub> =2×I <sub>GT</sub> )	dl/dt	50	A/µs
Peak gate current	I <sub>GM</sub>	4	Α
Average gate power dissipation	P <sub>G(AV)</sub>	1	W
Peak gate power	P <sub>GM</sub>	5	W

# **ELECTRICAL CHARACTERISTICS** ( $T_j$ =25 $^{\circ}$ C unless otherwise specified)

Symbol	Toot Condition	Value			11:4
	Test Condition	MIN.	TYP.	MAX.	Unit
Ідт	V <sub>D</sub> =12V R <sub>L</sub> =33Ω	1	-	25	mA
V <sub>G</sub> T	VD-12V KL-3312	1	-	1.3	V
V <sub>GD</sub>	$V_D = V_{DRM} T_j = 150 ^{\circ} C R_L = 3.3 K\Omega$	0.2	-	-	V
IL	I <sub>G</sub> =1.2I <sub>GT</sub>	1	-	70	mA
I <sub>H</sub>	I <sub>T</sub> =500mA	-	_	60	mA
dV/dt	V <sub>D</sub> =2/3V <sub>DRM</sub> Gate Open T <sub>j</sub> =150℃	200	-	-	V/µs

# **STATIC CHARACTERISTICS**

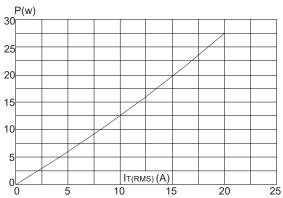
Symbol	Parameter		Value(MAX)	Unit
V <sub>TM</sub>	I <sub>TM</sub> =40A tp=380μs	T <sub>j</sub> =25℃	1.55	V
IDRM	VD=VDRM VR=VRRM	T <sub>j</sub> =25℃	5	μA
IRRM		Tj=150℃	4	mA

## THERMAL RESISTANCES

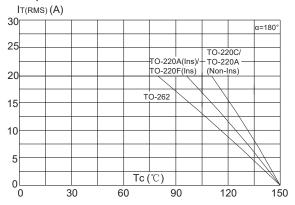
Symbol	Parameter		Value	Unit
R <sub>th(j-c)</sub>	junction to case(AC)	TO-220A(Ins)	2.1	°C/W
		TO-220A(Non-Ins)/ TO-220C	1.1	
		TO-220F(Ins)	2.2	
		TO-262	2.5	

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**FIG.1:** Maximum power dissipation versus RMS on-state current



**FIG.2:** RMS on-state current versus case temperature





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FIG.3: Surge peak on-state current versus number of cycles

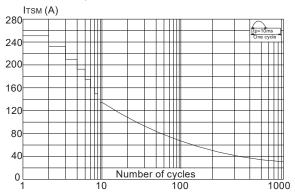


FIG.5: Non-repetitive surge peak on-state current for a sinusoidal pulse with width tp<10ms, and corresponging value of I2t

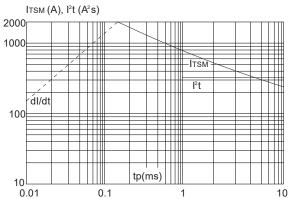


FIG.4: On-state characteristics (maximum values)

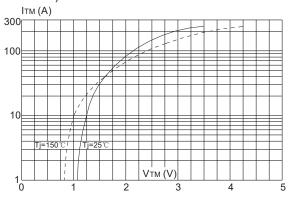


FIG.6: Relative variations of gate trigger current, holding current and latching current versus junction temperature

